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STF7N105K5

N-channel 1050 V, 1.4 Ω typ., 4 A MDmesh™ K5 Power MOSFET in TO-220FP package

Datasheet - production data

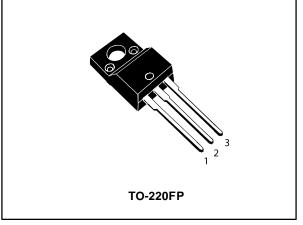
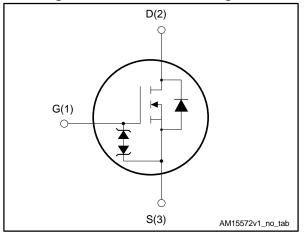


Figure 1: Internal schematic diagram



Features

Order code	V ds	RDS(on) max.	ΙD	Ртот
STF7N105K5	1050 V	2.0 Ω	4 A	25 W

- Industry's lowest R_{DS(on)} x area
- Industry's best FoM (figure of merit)
- Ultra-low gate charge
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

This very high voltage N-channel Power MOSFET is designed using MDmesh[™] K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

Order code	Marking	Package	Packaging
STF7N105K5	7N105K5	TO-220FP	Tube

DocID026184 Rev 2

This is information on a product in full production.

Contents

Contents

1	Electric	al ratings	3
2	Electric	al characteristics	4
	2.1	Electrical characteristics (curves)	6
3	Test cir	cuits	9
4	Packag	e information	10
	4.1	TO-220FP package information	11
5	Revisio	on history	13



1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vgs	Gate- source voltage	± 30	V
ID	Drain current (continuous) at $T_c = 25 \ ^{\circ}C$	4 ⁽¹⁾	А
ID	Drain current (continuous) at T _c = 100 °C	3 ⁽¹⁾	А
I _{DM} ⁽²⁾	Drain current (pulsed)	16	А
P _{TOT}	Total dissipation at $T_C = 25 \text{ °C}$	25	W
I _{AR}	Max. current during repetitive or single pulse avalanche	1.5	А
E _{AS}	Single pulse avalanche energy (starting $T_J = 25 \text{ °C}$, $I_D = I_{AR}$, $V_{DD} = 50 \text{ V}$)		mJ
V _{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink (t = 1 s; $T_C = 25$ °C)	2500	V
dv/dt (3)	Peak diode recovery voltage slope	4.5	V/ns
dv/dt (4)	MOSFET dv/dt ruggedness	50	V/ns
Tj	Operating junction temperature range	- 55 to 150	°C
T _{stg}	T _{stg} Storage temperature range		C

Notes:

⁽¹⁾Limited by package.

 $\ensuremath{^{(2)}}\ensuremath{\mathsf{Pulse}}$ width limited by safe operating area.

 $^{(3)}I_{SD} \leq 4$ A, di/dt \leq 100 A/µs, V_DS(peak) \leq V(BR)DSS ; V_SD \leq 840 V

 $^{(4)}\mathsf{V}_\mathsf{DS} \leq 840 \; \mathsf{V}$

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	5	°C/W
R _{thj-amb}	Thermal resistance junction-amb max	62.5	°C/W



2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified).

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(\text{BR})\text{DSS}}$	Drain-source breakdown voltage	V_{GS} = 0 V, I_D = 1 mA	1050			V
	IDSS Zero gate voltage drain current	V_{GS} = 0 V, V_{DS} = 1050 V			1	μA
IDSS		$V_{GS} = 0 V, V_{DS} = 1050 V,$ T _C =125 °C ⁽¹⁾			50	μA
I _{GSS}	Gate body leakage current	$V_{DS} = 0, V_{GS} = \pm 20 V$			±10	μA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 100 \ \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on- resistance	V _{GS} = 10 V, I _D = 2 A		1.4	2	Ω

Notes:

⁽¹⁾Defined by design, not subject to production test.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	380	-	pF
Coss	Output capacitance	V _{DS} =100 V, f=1 MHz, V _{GS} =0 V	-	40	-	pF
Crss	Reverse transfer capacitance	VDS = 100 V, 1 = 1 101 12, VGS=0 V	-	0.65	-	pF
C _{o(tr)} ⁽¹⁾	Equivalent capacitance time related		-	47	-	pF
C _{o(er)} ⁽²⁾	Equivalent capacitance energy related	$V_{GS} = 0 V, V_{DS} = 0 to 840 V$	-	17	-	pF
R _G	Intrinsic gate resistance	f = 1MHz open drain	-	7	-	Ω
Qg	Total gate charge	V _{DD} = 840 V, I _D = 4 A	-	11	-	nC
Qgs	Gate-source charge	V _{GS} =10 V	-	2.8	-	nC
Q_gd	Gate-drain charge	Figure 16: "Test circuit for gate charge behavior"	-	5.6	-	nC

Table 5: Dynamic

Notes:

 $^{(1)}$ Time related is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

 $^{(2)} Energy$ related is defined as a constant equivalent capacitance giving the same stored energy as C_{OSS} when V_{DS} increases from 0 to 80% V_{DSS}



Electrical characteristics

	Table 6: Switching times							
Symbol	Parameter	Min.	Тур.	Max.	Unit			
t _{d(on)}	Turn-on delay time	$V_{DD} = 525 \text{ V}, \text{ I}_D = 2 \text{ A}, \text{ R}_G = 4.7 \Omega,$	-	17.5	-	ns		
tr	Rise time	V _{GS} =10 V (see Figure 15: "Test circuit for resistive load switching times" and		7	I	ns		
t _{d(off)}	Turn-off delay time			43	I	ns		
t _f	Fall time	Figure 20: "Switching time waveform")	-	25	-	ns		

Table 7: Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Isd	Source-drain current		-		4	А
ISDM	Source-drain current (pulsed)				16	А
Vsd ⁽¹⁾	Forward on voltage	I _{SD} = 4 A, V _{GS} =0	-		1.6	V
t _{rr}	Reverse recovery time	I _{SD} = 4 A, V _{DD} = 60 V	-	370		ns
Qrr	Reverse recovery charge	di/dt = 100 A/µs,	-	3		μC
I _{RRM}	Reverse recovery current	Figure 17: "Test circuit for inductive load switching and diode recovery times"	-	16.5		A
trr	Reverse recovery time	I _{SD} = 4 A,V _{DD} = 60 V	-	600		ns
Qrr	Reverse recovery charge	di/dt=100 A/µs, Tj=150 °C	-	4.4		μC
Irrm	Reverse recovery current	Figure 17: "Test circuit for inductive load switching and diode recovery times"	-	14.5		A

Notes:

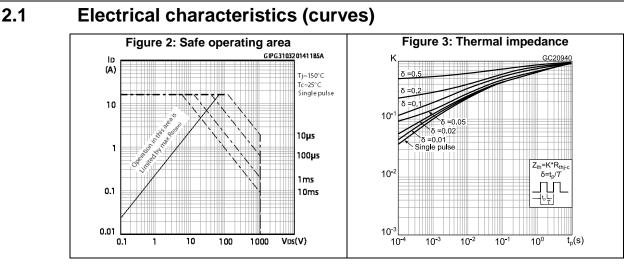
 $^{(1)}$ Pulsed: pulse duration = 300µs, duty cycle 1.5%

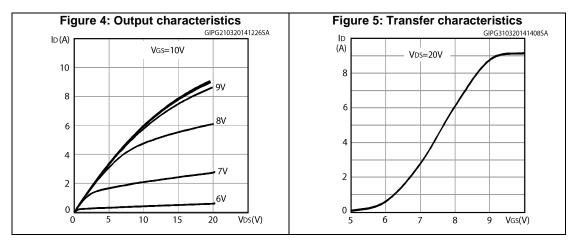
Table 8: Gate-source Zene	r diode
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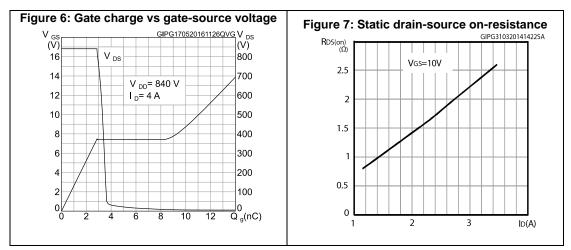
Symbol	Parameter	Test conditions	Min	Тур.	Max.	Unit
V _(BR) GSO	Gate-source breakdown voltage	$I_{GS} = \pm 1 \text{mA}, I_{D}=0$	30	-	•	V

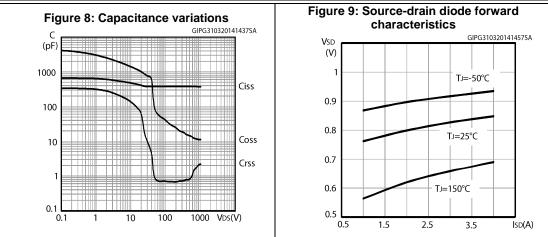
The built-in back-to-back Zener diodes have been specifically designed to enhance the ESD capability of the device. The Zener voltage is appropriate for efficient and cost-effective intervention to protect the device integrity. These integrated Zener diodes thus eliminate the need for external components.

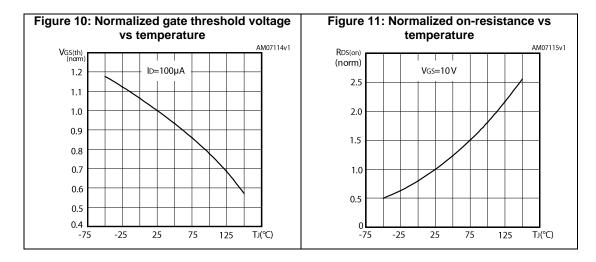
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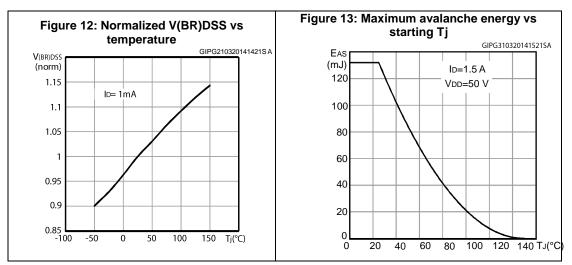








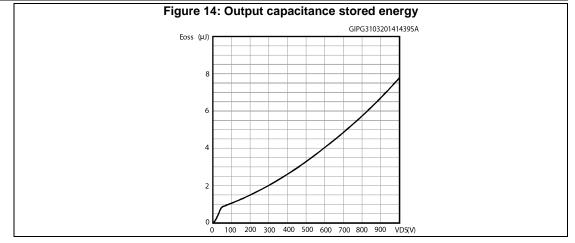




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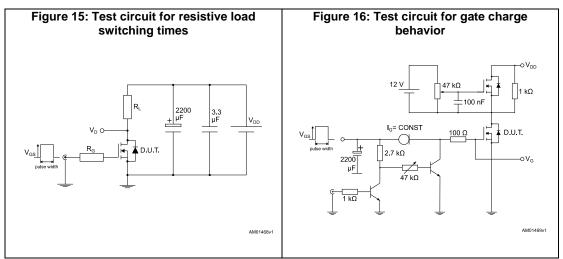
Electrical characteristics

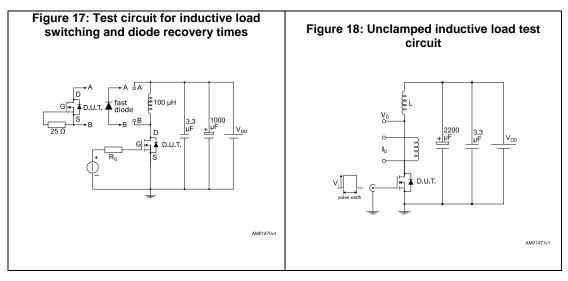
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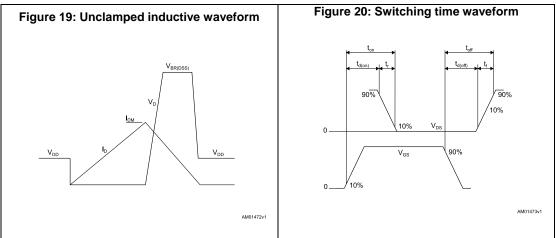




3 Test circuits







57

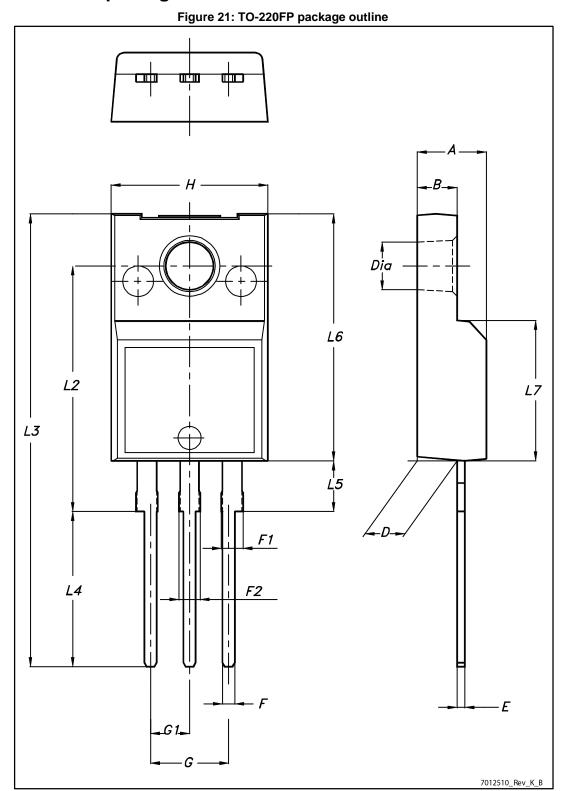
4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.



57

4.1 TO-220FP package information



Package information

Table 9: TO-220FP package mechanical data

STF7N105K5

Table 9: TO-220FP package mechanical data						
Dim.		mm				
Dim.	Min.	Тур.	Max.			
A	4.4		4.6			
В	2.5		2.7			
D	2.5		2.75			
E	0.45		0.7			
F	0.75		1			
F1	1.15		1.70			
F2	1.15		1.70			
G	4.95		5.2			
G1	2.4		2.7			
Н	10		10.4			
L2		16				
L3	28.6		30.6			
L4	9.8		10.6			
L5	2.9		3.6			
L6	15.9		16.4			
L7	9		9.3			
Dia	3		3.2			



5 Revision history

Date	Revision	Changes
07-Apr-2014	1	First release.
07-Jun-2016	2	Updated <i>Figure 6: "Gate charge vs gate-source voltage"</i> and <i>Table 5: "Dynamic"</i> . Minor text changes.



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